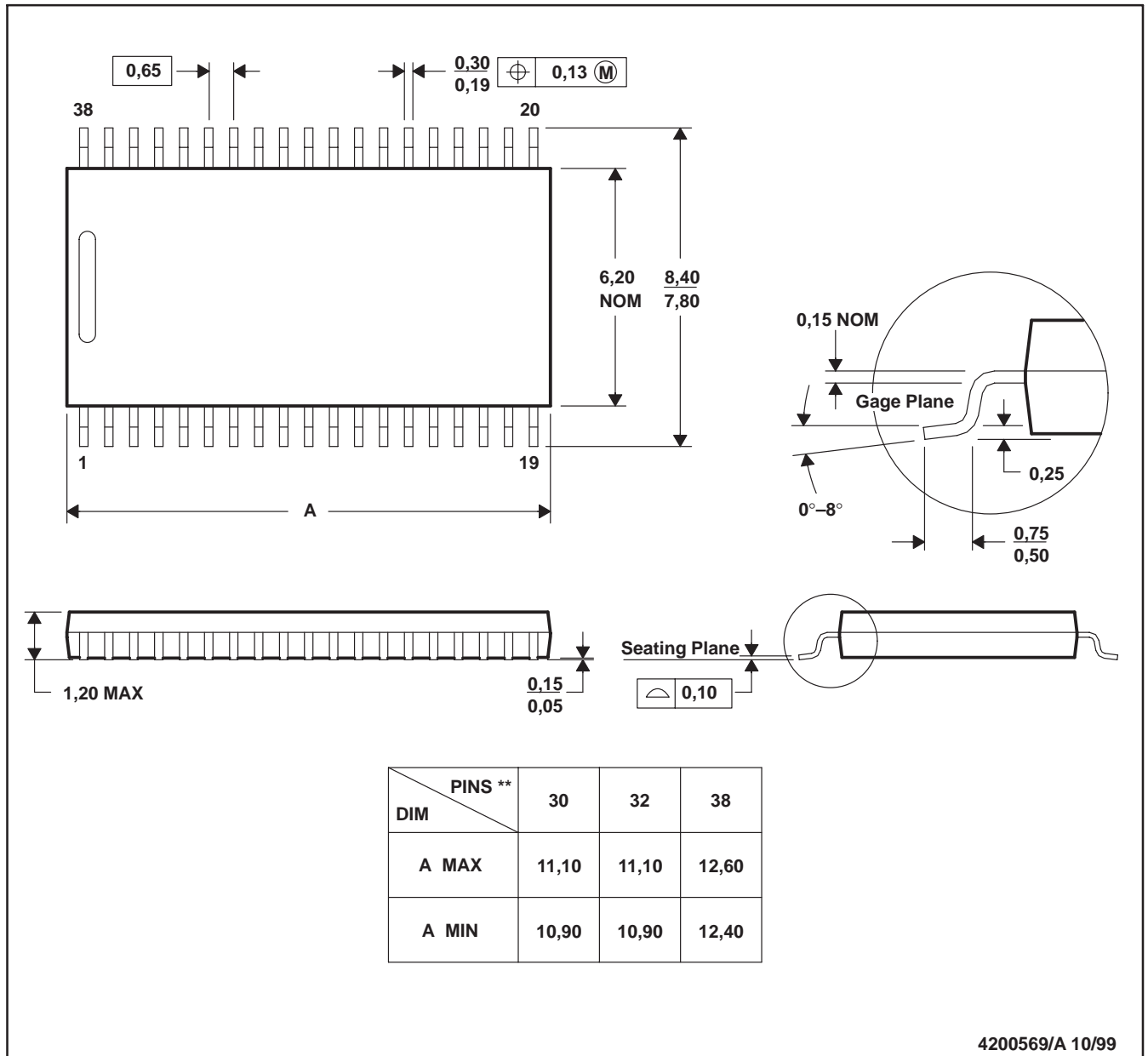


DAE (R-PDSO-G**)

PLASTIC SMALL-OUTLINE (DIE DOWN)

38 PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion.
 - D. Falls within JEDEC MO-153

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